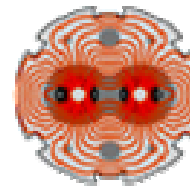




TCDS DILUTER TO PROTECT MSD SEPTUM MAGNETS



FUNCTIONAL SPECIFICATION LHC-TCDS-ES-0001

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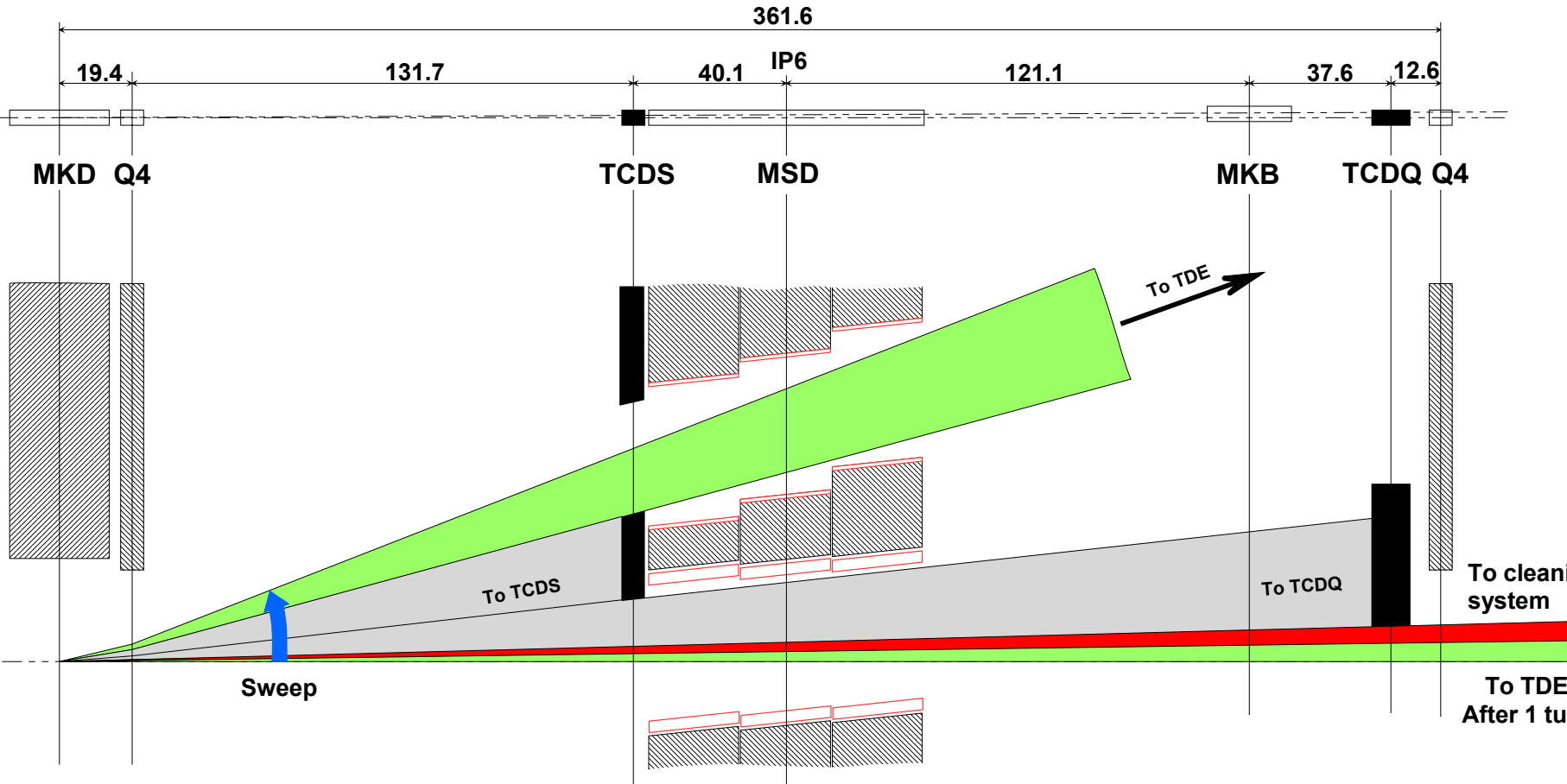
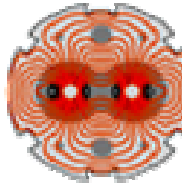
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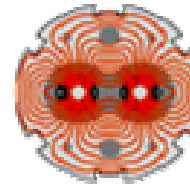


INTRODUCTION





OPERATION CONDITIONS



LHC BEAM INTENSITY AND ENERGY [1]

- 7 TeV Proton Beam Energy
- 2808 Bunches, 24.95 ns spacing, $1.1 \cdot 10^{11}$ Particles/Bunch
- 350 MJ stored Energy

PERFORMANCE OBJECTIVE TCDS [2]

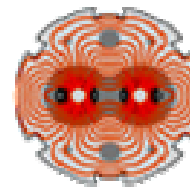
- **What:** dilute about 6.1 MJ, $\sim 1.7\%$ of LHC beam energy.
- **When:** Event of an unsynchronised beam abort of the MKD kickers at baseline luminosity and $1.2\mu\text{s}$ delay.

EXTRACTION PARAMETERS

- Bunch is deflected proportionally to the kicker strength.
- Kicker waveform consisting of a linear ramp of $2.76\mu\text{s}$ rise time, bunch separation of 24.95ns.
- The distance between bunch hits is calculated using:
 - The extreme orbit trajectories at the TCDS position,
 - The dimensions and position of the TCDS in the IP6 line,
 - The kicker strength and parameters.



DESIGN REQUIREMENTS AND CONSTRAINTS - 1



MATERIALS

- Thermal, Mechanical, Impedance, Vacuum, Radiological and Environmental constraints.

VACUUM SYSTEM [3]

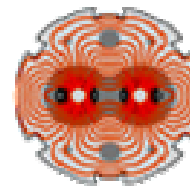
- Compatible with room temperature beam vacuum system of the LHC LSS
- Nominal pressure of $<10^{-8}$ Pa, Leak tested $1 \cdot 10^{-11}$ Pa.m³/s.
- Compatible with an *in-situ* bake-out to at least 250°C for 24 hours.

IMPEDANCE [4]

- Low electrical resistivity -> low transverse machine impedance.
- The surface resistance $R_s < 3.906 \cdot 10^{-11} d^3$ W. (d = beam screen ID)



CONCEPTUAL DESIGN - 1



◆ CONFIGURATION

■ Considering:

- Choice of Absorber materials and

Maximum Temperatures:

- MSD Vacuum chamber (300°C)
- MSD Steel Yoke (100°C)

- Baseline Solution [6]:

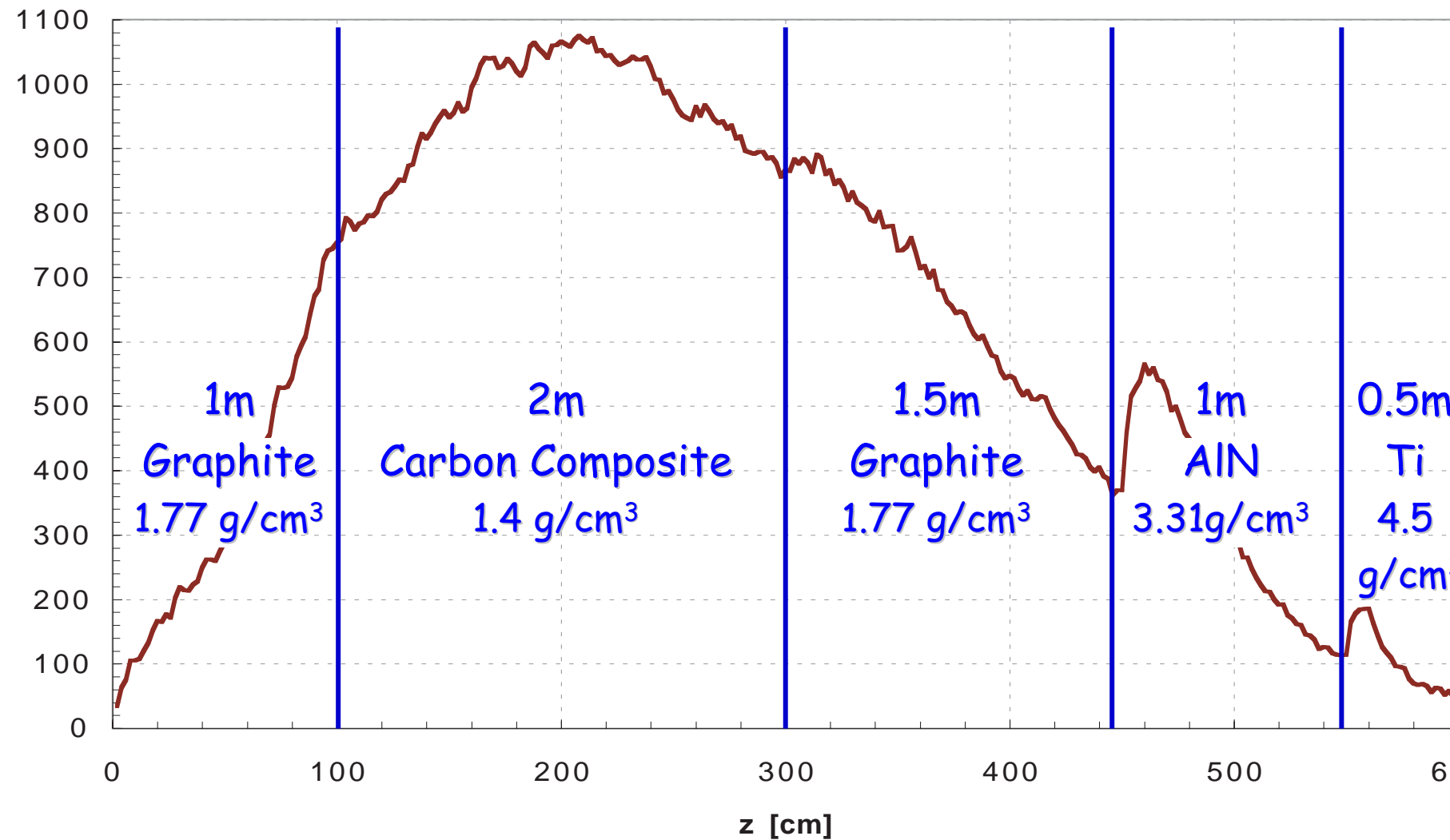
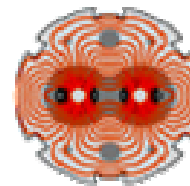
- 1m C, 2m C-C, 1.5m C, 1m AlN, 1m Ti

- Alternative Solution (pending tests):

- 1m C, 2m C-C, 1.5m C, 1m SiN, 1m Ti
- 4.5m C-C, 1m AlN, 1m Ti
- 4.5m C-C, 1m Al, 1m Ti

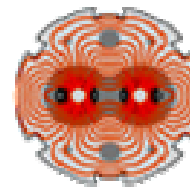


CONCEPTUAL DESIGN - 2



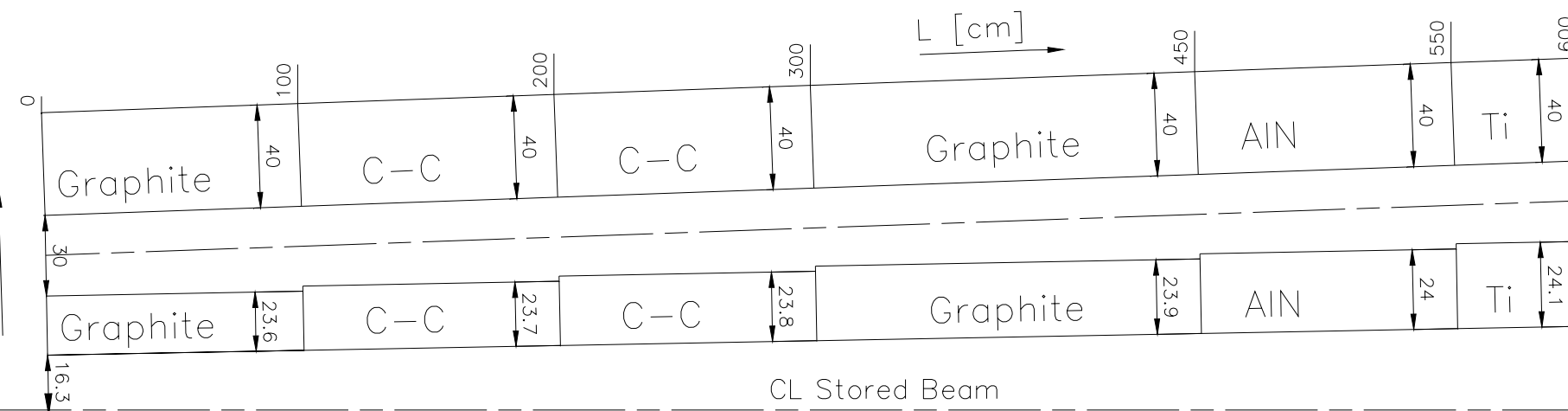


CONCEPTUAL DESIGN - 3



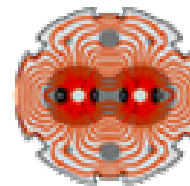
DIMENSIONS

- The ideal TCDS configuration is wedge-shaped.
- To avoid manufacture, assembly and alignment difficulties an approximate configuration with increasing thickness is proposed.
- A 2nd jaw, giving a clear aperture of 30mm, to protect the MSD from particles outside the aperture.



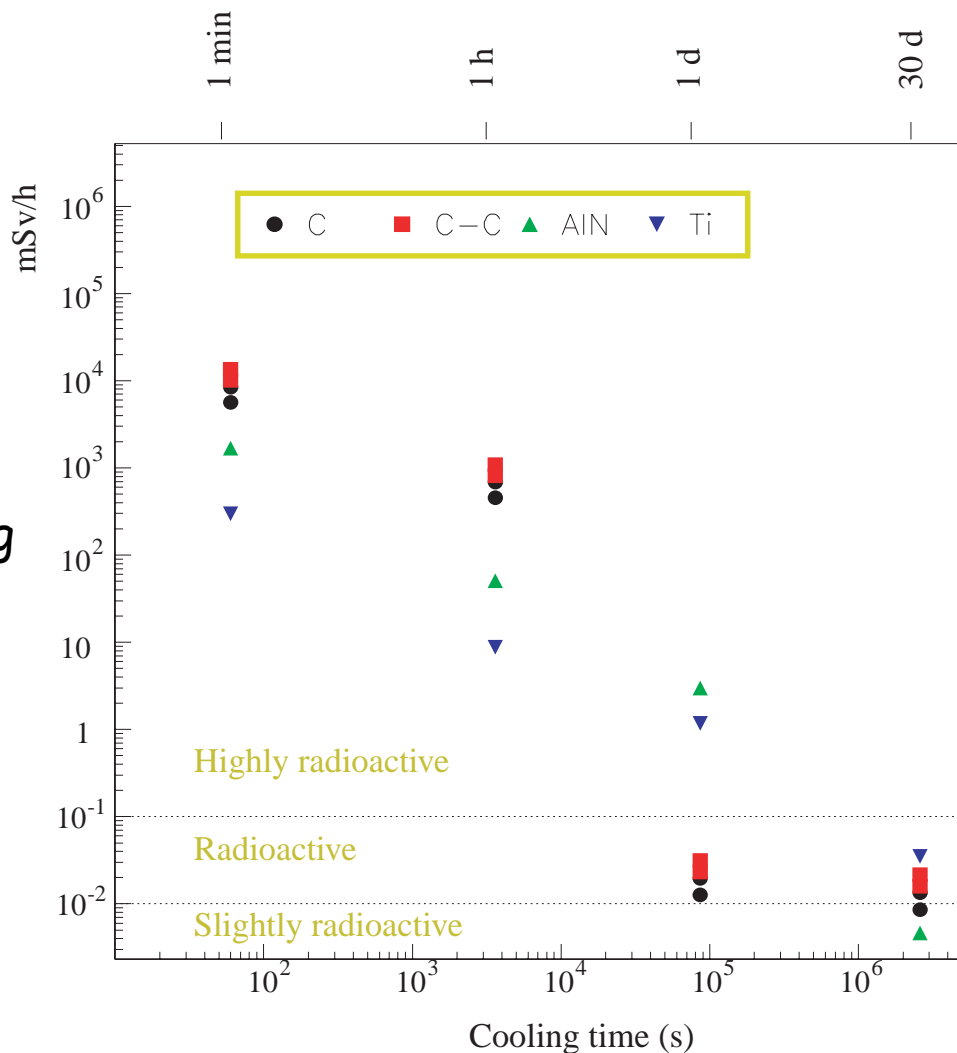


CONCEPTUAL DESIGN - 4



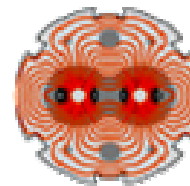
RADIOLOGICAL AND ENVIRONMENTAL ISSUES

- Dose rate at 30cm from the object after one unsynchronised beam abort.
- After impact and 1 day cooling period $\sim 3\text{mSv/h}$.
- After impact and of 30 days cooling period $\sim 0.035\text{mSv/h}$.





CONCEPTUAL DESIGN - 5



COOLING REQUIREMENTS

- A 500W cooling system to absorb the estimated 40W/m power deposited by the beam [7]. (.....is factor 2 safety enough?)

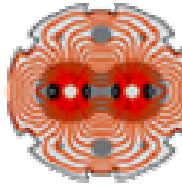
THERMO MECHANICAL STRESSES AND DILATATION

- Thermal behaviour and stresses analyses is treated in a separate technical specification [8].
- The design must take into account the estimated thermal expansion of the TCDS absorber elements due to bake-out and beam impact.

Material	ΔL Impact [mm]	ΔL 250°C [mm]
Graphite	0.2 (80°C)	0.9
C-C Composite	0.6 (190°C)	0.8
Graphite	0.9 (185°C)	1.3
Aluminium Nitride	0.6 (130°C)	1.2
Titanium	0.2 (50°C)	1.2



MECHANICAL DESIGN - 1



VACUUM VESSEL/EQUIPMENT

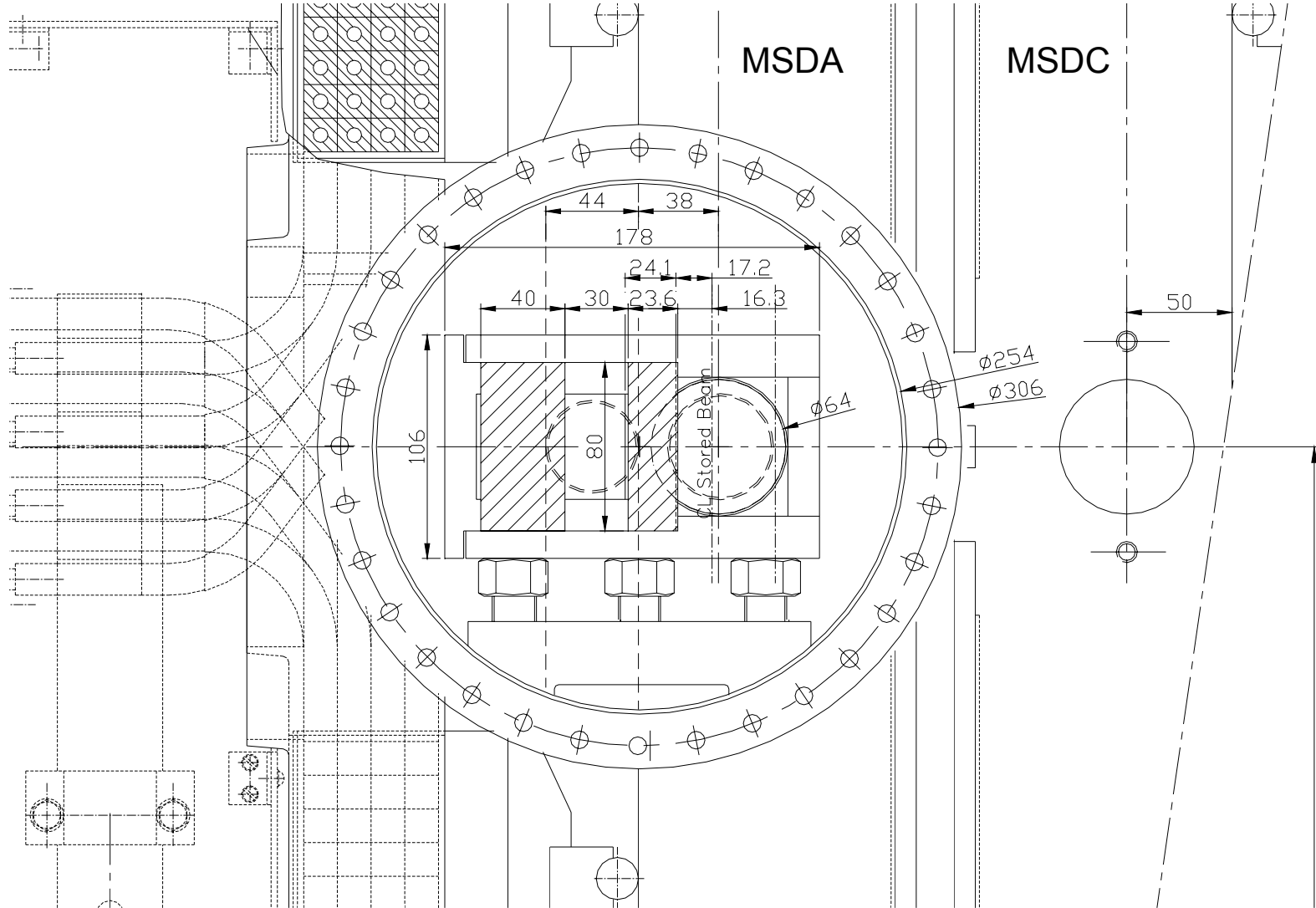
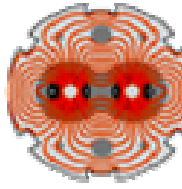
- Maximum OD Ø350mm (interference adjacent LHC vacuum tube), Maximum length <7.18m (compatibility CERN cleaning baths)
- Manufacture, assembly & alignment tolerances. of $\pm 1\text{mm}$.
- No use of halogen containing brazing flux (corrosion) and *In-situ* welding must be avoided. (Cleaning and Conditioning problems).
- Interconnection bellows (thermal expansion/contraction) shall assure continuity of electrical conductivity.
- Two 400 l/s ion-pumps and two sublimators (CO and CH families) [9].
- The vacuum vessel of 316 L(N) (300°C external bake by heating jackets).

BEAM SHIELDING

- Beam screen for LHC stored beam with a minimum clear aperture of 48.4mm (MSDA).
- All cavities, should be shielded with transitions angles 15°, surface roughness $200\text{ }\mu\text{m}$[4].
- Bellows shielded with impedance of $\leq 0.1\text{m}\Omega$. Contact resistance between chambers $100\text{ m}\Omega$ [3].
- Pumping slots with a surface area of up to 20%, rounded corners and their major axis is in the beam direction.

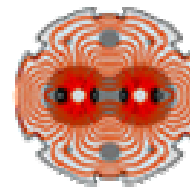


MECHANICAL DESIGN - 2

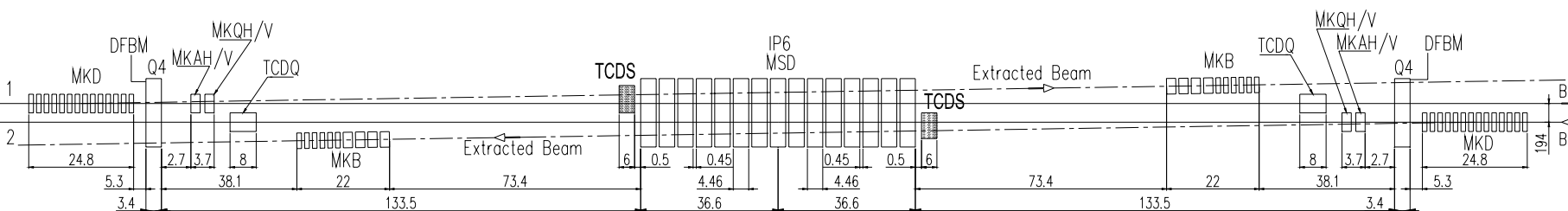




LAYOUT AND INTEGRATION



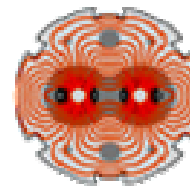
◆ SCHEMATIC LAYOUT



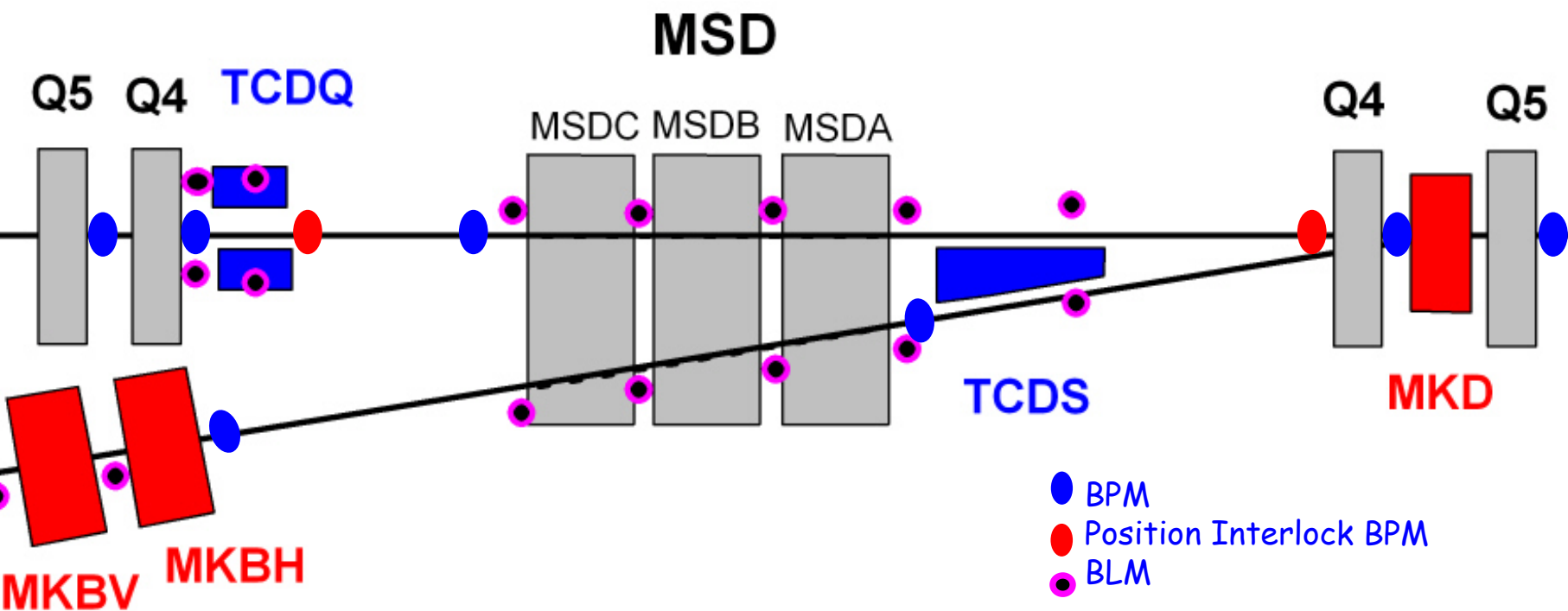
- The TCDS vacuum vessel will be fitted with DN250 conflat flanges at each end for connection to the LHC room temperature beam vacuum system and to the MSD pumping module.
- The TCDS will not be isolated from the other equipment by special sector valves.



INSTRUMENTATION

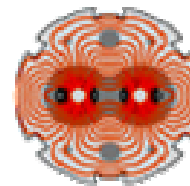


- Temperature sensors to monitor the temperature profile.
- Flow-meters and temperature gauges to monitor the cooling system.
- Beam position monitors (BPM) (horizontal and vertical plane) to monitor the position of the extracted and circulating beams [10].
- Loss monitors (BLMs) around the TCDS diluter blocks.





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- [1] LHC Design performance, Nominal Beam Parameters, accessed November 2002 on <http://edmsoraweb.cern.ch/>.
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- [6] M. Sans, Simulations of energy deposition and adiabatic temperature rise in the TCDS, LHC Project Note, to be published, 2003.
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